#### **Schottky Diodes** Reverse Voltage-40to200v Forward current-5A

#### **Features**

Schottky chip

Ldeal for surface mounted applications

Low forward voltage drop, Low power loss, high efficiency

Plastic Case Material has UL Flammability

#### Mechanical Data

Package: SMC

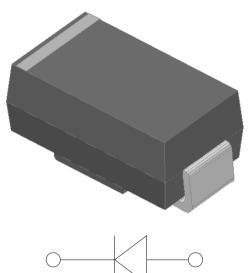
Terminals:Tin Plated leads, solderable per

Mil-STD-750 Method 2026

Polarity: As marked

Molding compound meets UL 94 V-0 flammability rating,

**ROHS-compliant** 





### Maximum Ratings (Ta=25°C Unless otherwise specified)

maximam ratings (14 25 c thists strict was specimen)								
Type Number		SS54C	SS56C	SS58C	SS510C	SS515C	SS520C	Umit
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	40	60	80	100	150	200	V
Maximum RMS Voltage		28	42	56	70	105	140	V
Maximum DC Blocking Voltage	$V_{DC}$	40	60	80	100	150	200	V
Maximum Average Forward Rectified Current	IO <sub>(AV)</sub>	5.0			Α			
Peak Forward Surge Current 8.3ms Single half-sine-wave superimposed on rated load(JEDEC Method) on rated	_ IFSM	100.0			Α			
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C		200.0			Α			
Current squared time @1ms≤t8.3≤ms Tj=25℃, Rating of per diode	l <sup>2</sup> t	41.5				A <sup>2</sup> S		
Maximum Forward Voltage at 5.0A DC	V <sub>FM</sub>	0.55	0.75	0.	85	0.	92	V
Maximum Reverse Current TA = 25℃	IR	0.1 0.05		mA				
at Rated DC Blocking Voltage TA = 100℃	IK IK	20 10			mA			
Typical Thermal Resistance	$R_{QJA}$	48.0		°C/W				
Operating Junction Temperature Range	T <sub>J</sub>	—55to+150			$^{\circ}$			
Storage Temperature Range	T <sub>STG</sub>	—55to+150			$^{\circ}\!\mathbb{C}$			

FIG. 1MAXIMUM AVERAGE FORWARD CURRENT DERATING

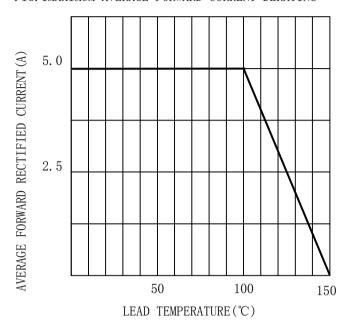
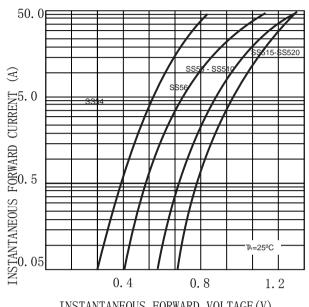


FIG. 2TYPICAL FORWARD CHARACTERISTICS



INSTANTANEOUS FORWARD VOLTAGE(V)

FIG. 3MAXIMUM NON-REPEITIVE SURGE CURRENT

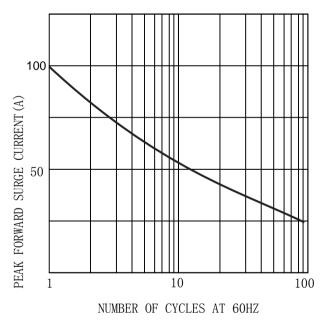
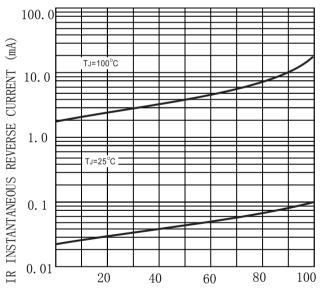


FIG. 4 TYPICAL REVERSE CHARACTERISTICS (per element)



PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

### **MARKING INFORMATION**



Signal = Logo

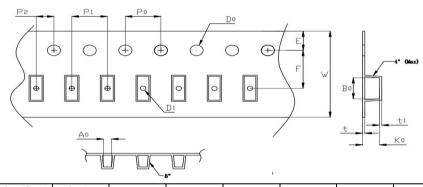
\*\*\*\* = Date Code Marking

SS\*\*\* = Marking Code

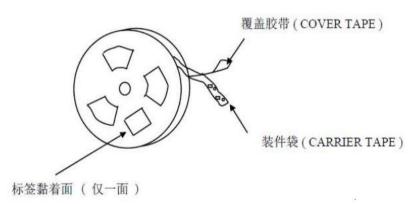
Print according to customer request

### **PACKING REQUIRMENTS**

Carrier tape packing

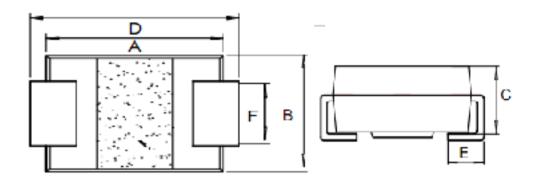


Specificati ons	Carrier tape type	Ao	Во	Ко	Ро	W	t	Exiplain
SMC	Anti-static	6.05±0.1	8.31±0.1	2.54±0.1	3.98±0.05	15.95±0.05	0.23±0.02	



DEVICE TYPE	Tape width	'Reel				
		Q'TY/REEL (pcs)	BOX/CAR TOON	Q'TY/REEL (pcs)		
SMC	13.3	3000	T/R	3000		

## Outline Dimensions



		SMC			
DIM	INC	HES	MM		
	MIN	MAX	MIN	MAX	
A	0.26	0. 28	6.6	7. 1	
В	0.22	0. 24	5. 5	6. 2	
С	0.08	0.10	2	2.6	
D	0.30	0.32	7. 7	8.2	
Е	/	0.06	/	1.5	
F	0.11	0. 13	2.9	3. 2	

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